

S/N 09/650,569

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Joseph E. Geusic et al.

Examiner: Kurt Eaton

Serial No.: 09/650,569

Group Art Unit: 2823

Filed: August 30, 2000

Docket: 303.390US3

Title: METHOD OF FORMING AN OPTICAL FIBER INTERCONNECT THROUGH  
A SEMICONDUCTOR WAFER(as amended)

**AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

Commissioner for Patents  
Washington, D.C. 20231

Applicant has reviewed the Office Action mailed on August 13, 2001. Please amend the above-identified patent application as follows.

**IN THE TITLE**

Please delete the title and replace it with the following title:

“METHOD OF FORMING AN OPTICAL FIBER INTERCONNECT THROUGH A  
SEMICONDUCTOR WAFER”

**REMARKS**

Applicant has carefully reviewed and considered the Office Action mailed on August 13, 2001, and the references cited therewith.

No claims are amended, no claims are canceled, and no claims are added; as a result, claims 39-72 remain pending in this application.

**Information Disclosure Statement**

Applicant respectfully requests that a copy of the 1449 Form, listing all references that were submitted with the Information Disclosure Statement filed on August 30, 2000, with the application, marked as being considered and initialed by the Examiner, be returned with the next official communication.